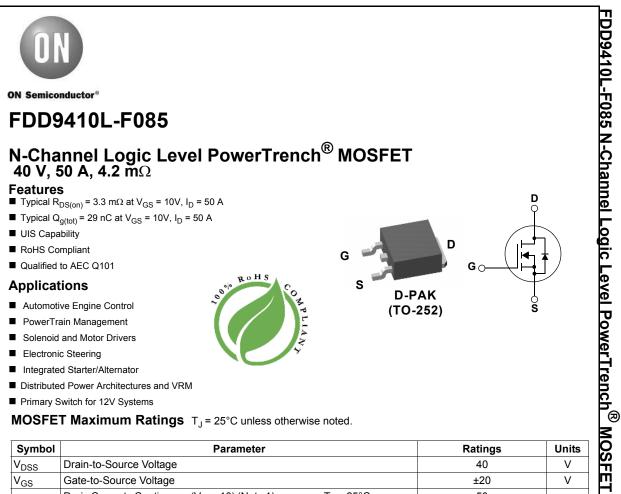
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Symbol	Parameter		Ratings	Units	
V _{DSS}	Drain-to-Source Voltage		40	V	
V _{GS}	Gate-to-Source Voltage		±20	V	
-	Drain Current - Continuous (V _{GS} =10) (Note 1)	T _C =25°C	50	•	
D	Pulsed Drain Current	T _C = 25°C	See Figure 4	Α	
E _{AS}	Single Pulse Avalanche Energy	(Note 2)	24	mJ	
6	Power Dissipation		75	W	
P _D	Derate Above 25°C		0.5	W/ ^o C	
T _J , T _{STG}	Operating and Storage Temperature		-55 to + 175	°C	
$R_{\theta JC}$	Thermal Resistance, Junction to Case		2	°C/W	
$R_{\theta JA}$	Maximum Thermal Resistance, Junction to Ambient	(Note 3)	52	°C/W	

Notes:

1: Current is limited by bondwire configuration.

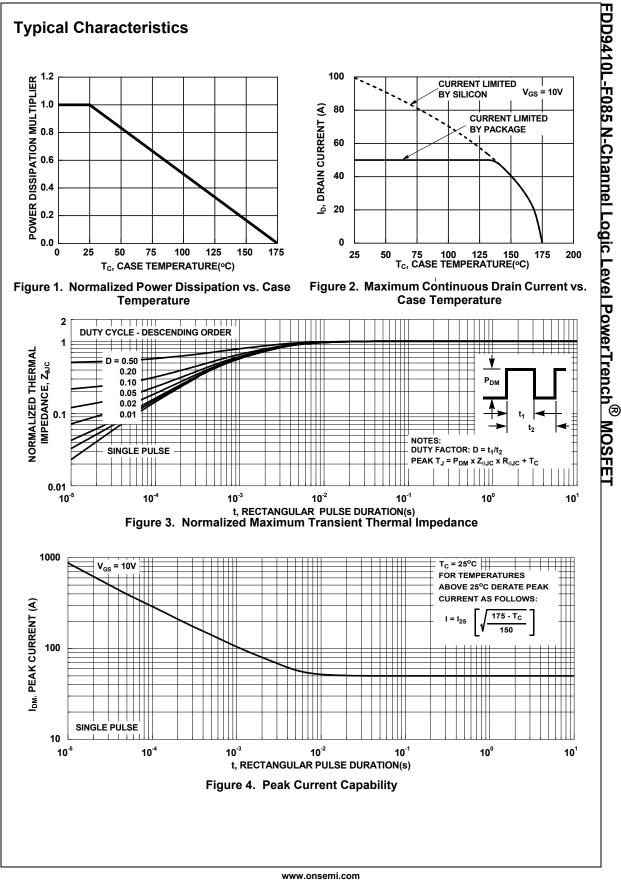
2: Starting $T_J = 25^{\circ}$ C, L = 30 μ H, $I_{AS} = 40$ A, $V_{DD} = 40$ V during inductor charging and $V_{DD} = 0$ V during time in avalanche.

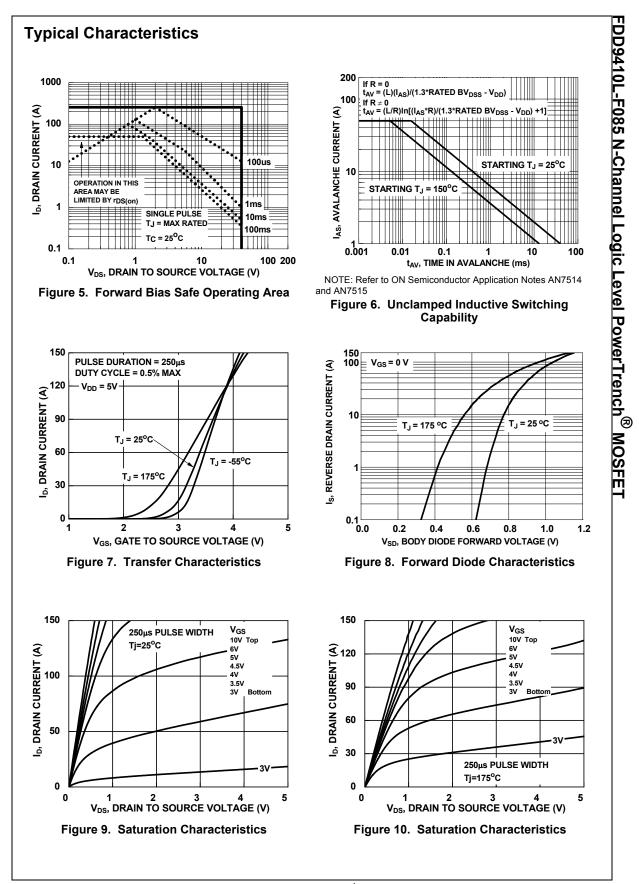
3: R_{0JA} is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{0JC} is guaranteed by design, while R_{0JA} is determined by the board design. The maximum rating presented here is based on mounting on a 1 in² pad of 2oz copper.

Package Marking and Ordering Information

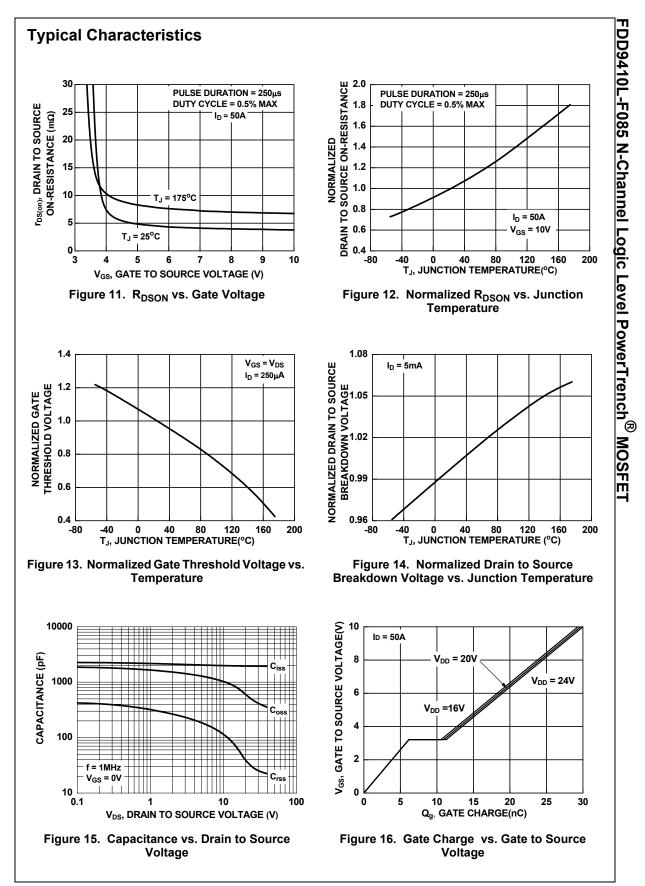
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDD9410L	FDD9410L-F085	D-PAK(TO-252)	13"	16mm	2500units

Symbol	Parameter	Test Conditions		Min.	Тур.	Max.	Units
Off Cha	racteristics						
B _{VDSS}	Drain-to-Source Breakdown Voltage	I _D = 250μA, V _{GS} = 0V		40	-	-	V
I _{DSS}	Drain-to-Source Leakage Current	V _{DS} =40V,	T _J = 25 ^o C	-	-	1	μA mA
I _{GSS}	Gate-to-Source Leakage Current	$V_{GS} = 0V \qquad T_J = 175^{\circ}C \text{ (Note 4)}$ $V_{GS} = \pm 20V$		-	-	±100	nA
On Cha	racteristics			_			
V _{GS(th)}	Gate to Source Threshold Voltage	V _{GS} = V _{DS} , I _D = 250μA		1.0	1.8	3.0	V
		I _D = 50A, V _G	_S = 4.5V	-	5.0	6.5	mΩ
R _{DS(on)}	Drain to Source On Resistance	I _D = 50A,	$T_J = 25^{\circ}C$	-	3.3	4.2	mΩ
. /			T _J = 175 ^o C (Note 4)	-	6.0	7.6	mΩ
Dynami	c Characteristics						
C _{iss}	Input Capacitance	V _{DS} = 20V, V _{GS} = 0V, f = 1MHz		-	1960	-	pF
C _{oss}	Output Capacitance			-	615	-	pF
C _{rss}	Reverse Transfer Capacitance			-	41	-	pF
R _g	Gate Resistance	f = 1MHz		-	1.9	-	Ω
Q _{g(ToT)}	Total Gate Charge	V _{GS} = 0 to 10	0V V _{DD} = 32V	-	29	43	nC
$Q_{g(th)}$	Threshold Gate Charge	$V_{GS} = 0$ to 2		-	4	-	nC
Q _{gs}	Gate-to-Source Gate Charge			-	6	-	nC
Q _{gd}	Gate-to-Drain "Miller" Charge			-	5	-	nC
Switchi	ng Characteristics						
t _{on}	Turn-On Time			-	-	22	ns
t _{d(on)}	Turn-On Delay	V_{DD} = 20V, I _D = 50A, V _{GS} = 10V, R _{GEN} = 6Ω		-	8	-	ns
t _r	Rise Time			-	7	-	ns
t _{d(off)}	Turn-Off Delay			-	25	-	ns
t _f	Fall Time			-	5	-	ns
off	Turn-Off Time	<u> </u>		-	-	45	ns
Drain-S	ource Diode Characteristics						
V _{SD}	Source to Drain Diade Valtage	I _{SD} =50A, V _{GS} = 0V		-	-	1.25	V
	Source-to-Drain Diode Voltage	I _{SD} = 25A, V		-	-	1.2	V
t _{rr}	Reverse-Recovery Time	$I_F = 50A, dI_{SD}/dt = 100A/\mu s$ $V_{DD} = 32V$		-	47	71	ns
Q _{rr}	Reverse-Recovery Charge			-	36	71	nC





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